

Typical Applications

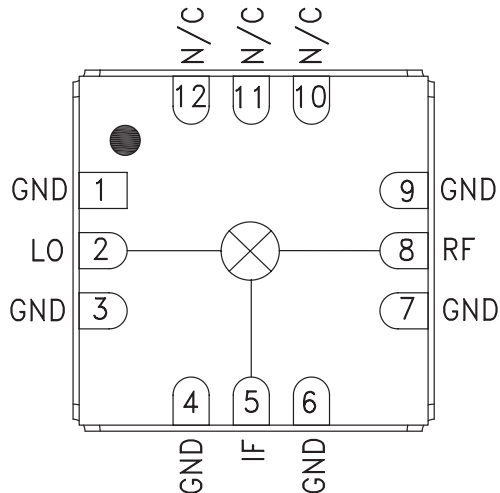
The HMC329LC3B is ideal for:

- Point-to-Point Radios
- Point-to-Mult-Point Radios & VSAT
- Test Equipment & Sensors
- Military End-Use

Features

- Passive: No DC Bias Required
- Input IP3: +18 dBm
- LO/RF Isolation: 38 dB
- Wide IF Bandwidth: DC - 8 GHz
- RoHS Compliant 3x3 mm SMT Package

Functional Diagram



General Description

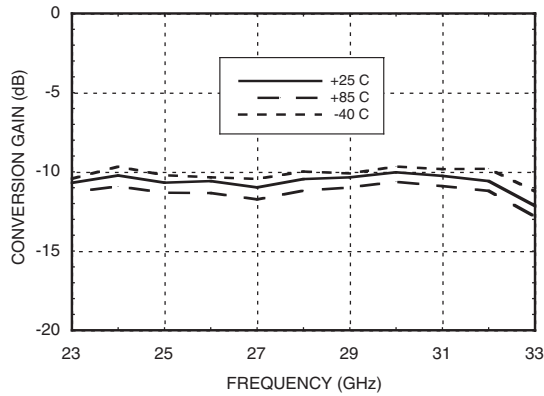
The HMC329LC3B is a general purpose double balanced mixer in a leadless RoHS compliant SMT package that can be used as an upconverter or downconverter between 24 and 32 GHz. This mixer requires no external components or matching circuitry. The HMC329LC3B provides excellent LO to RF and LO to IF suppression due to optimized balun structures. The mixer operates with LO drive levels above +9 dBm. The HMC329LC3B eliminates the need for wire bonding, allowing use of surface mount manufacturing techniques.

Electrical Specifications, $T_A = +25^\circ \text{C}$, $IF = 1 \text{ GHz}$, $LO = +13 \text{ dBm}$ *

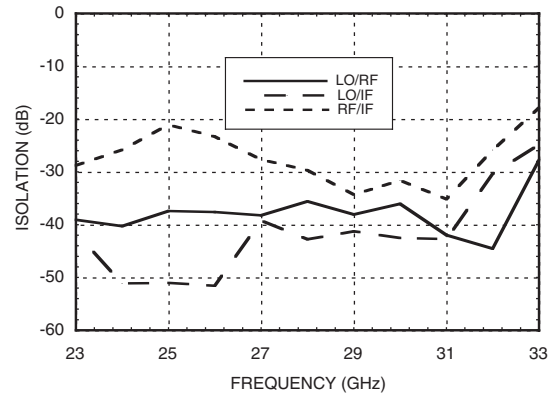
Parameter	Min.	Typ.	Max.	Units
Frequency Range, RF & LO	24 - 32			GHz
Frequency Range, IF	DC - 8			GHz
Conversion Loss		10.5	12.5	dB
Noise Figure (SSB)		10.5	12.5	dB
LO to RF Isolation	32	38		dB
LO to IF Isolation	26	40		dB
RF to IF Isolation	20	30		dB
IP3 (Input)		18		dBm
IP2 (Input)		40		dBm
1 dB Gain Compression (Input)		13		dBm

*Unless otherwise noted, all measurements performed as downconverter, $IF = 1 \text{ GHz}$.

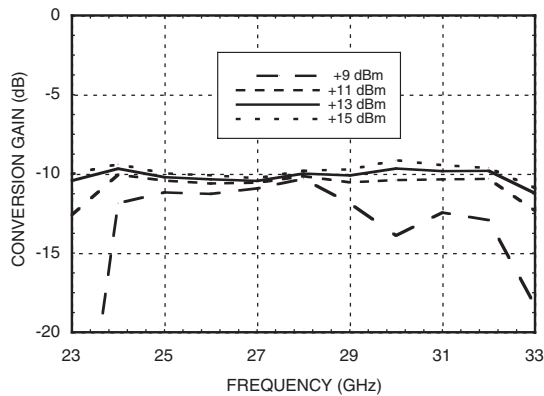
Conversion Gain vs. Temperature



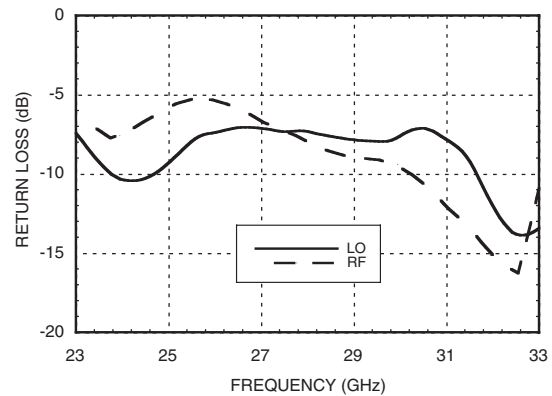
Isolation



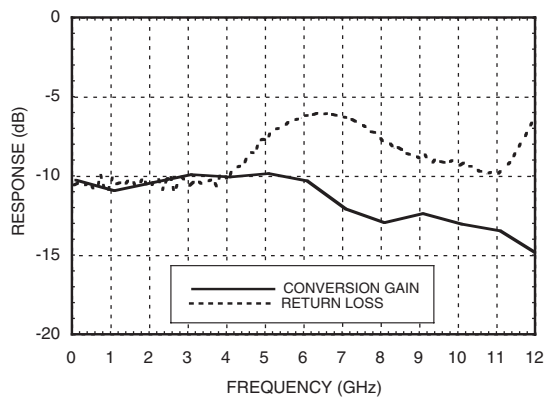
Conversion Gain vs. LO Drive



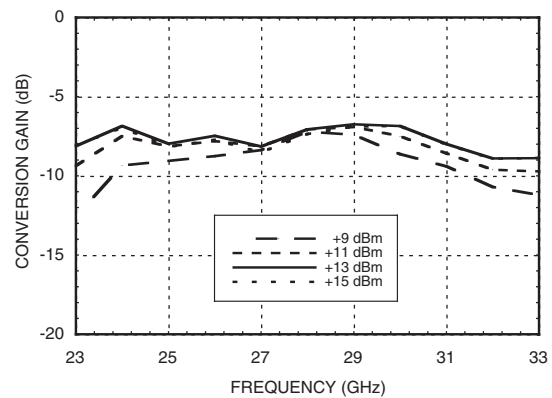
Return Loss



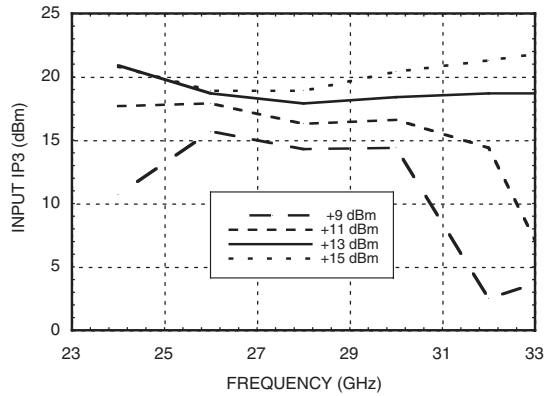
IF Bandwidth



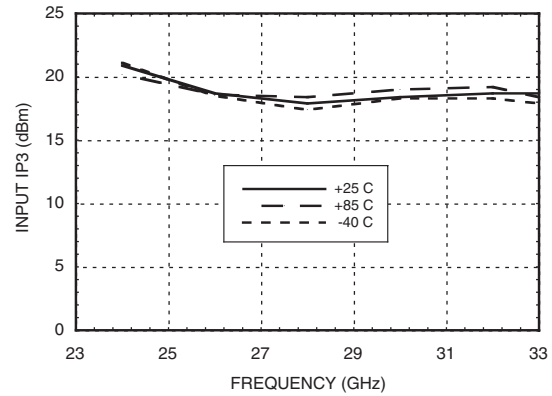
Upconverter Performance Conversion Gain vs. LO Drive



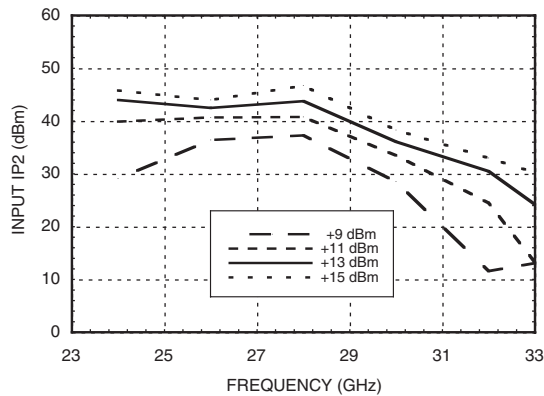
Input IP3 vs. LO Drive *



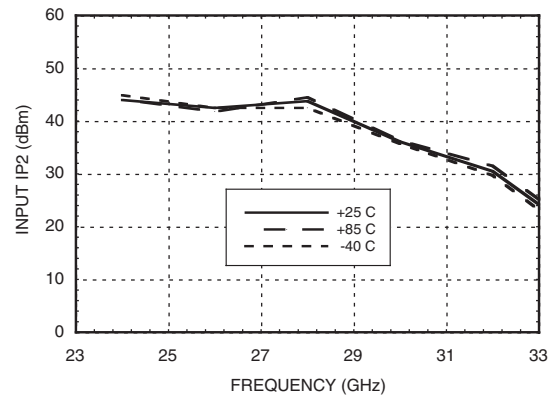
Input IP3 vs. Temperature *



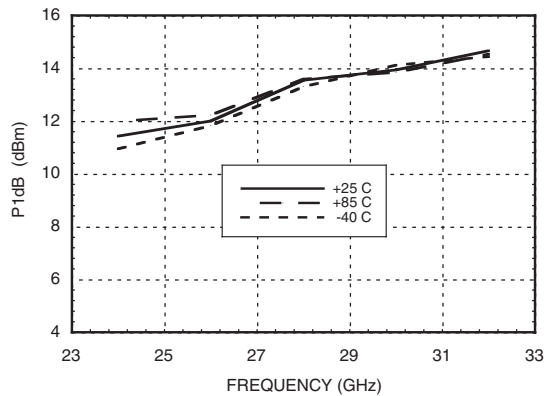
Input IP2 vs. LO Drive *



Input IP2 vs. Temperature *



Input P1dB vs. Temperature



MxN Spurious Outputs

	nLO				
mRF	0	1	2	3	4
0	xx	9	xx	xx	xx
1	20	0	42	xx	xx
2	xx	72	58	80	xx
3	xx	xx	98	70	90
4	xx	xx	xx	100	104

RF = 28 GHz @ -10 dBm
 LO = 27 GHz @ +13 dBm
 All values in dBc below the IF output power level.

* Two-tone input power = -10 dBm each tone, 1 MHz spacing.

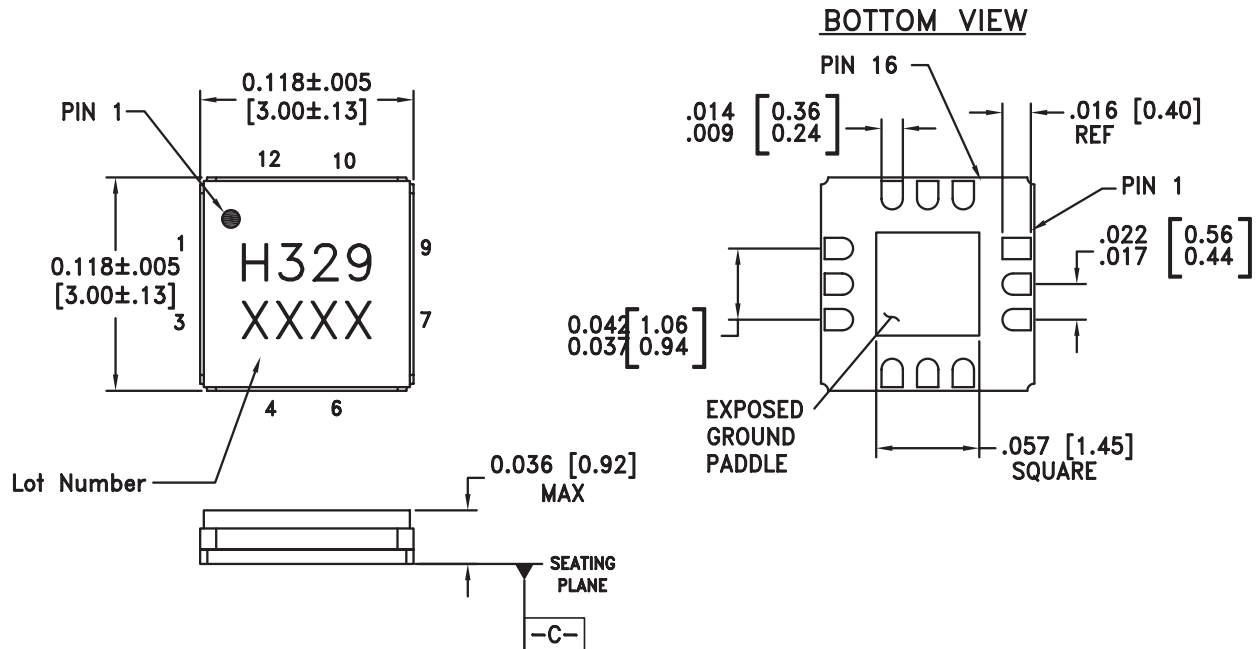
Absolute Maximum Ratings

RF / IF Input	+13 dBm
LO Drive	+27 dBm
Channel Temperature	150 °C
Continuous P _{diss} (T _a = 85 °C) (derate 5.88 mW/°C above 85 °C)	382 mW
Thermal Resistance (junction to ground paddle)	170 °C/W
Storage Temperature	-65 to +150 °C
Operating Temperature	-40 to +85 °C
ESD Sensitivity (HBM)	Class 1B



ELECTROSTATIC SENSITIVE DEVICE
OBSERVE HANDLING PRECAUTIONS


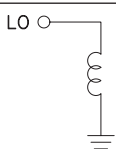
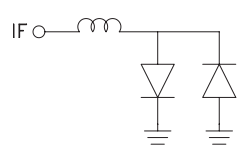
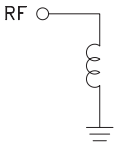
Outline Drawing



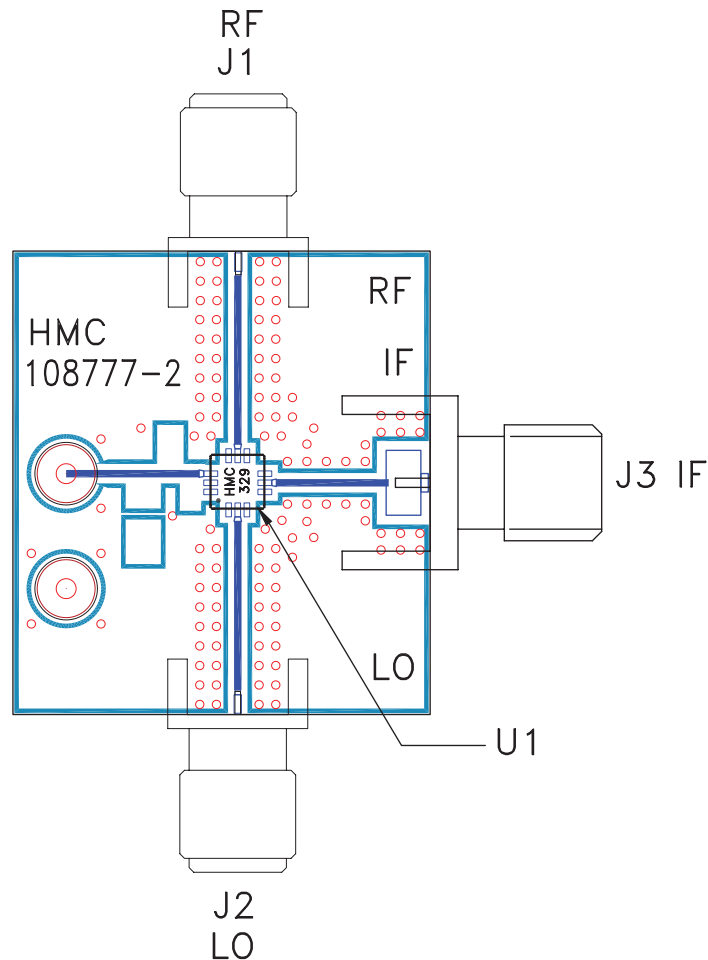
NOTES:

1. PACKAGE BODY MATERIAL: ALUMINA.
2. LEAD AND GROUND PADDLE PLATING: GOLD FLASH OVER NICKEL.
3. DIMENSIONS ARE IN INCHES (MILLIMETERS).
4. LEAD SPACING TOLERANCE IS NON-CUMULATIVE.
5. CHARACTERS TO BE HELVETICA MEDIUM, .025 HIGH, BLACK INK, OR LASER MARK LOCATED APPROX. AS SHOWN.
6. PACKAGE WARP SHALL NOT EXCEED 0.05MM DATUM - C -
7. ALL GROUND LEADS AND GROUND PADDLE MUST BE SOLDERED TO PCB RF GROUND.
8. CLASSIFIED AS MOISTURE SENSITIVITY LEVEL (MSL) 1.

Pin Descriptions

Pin Number	Function	Description	Interface Schematic
1, 3, 4, 6, 7, 9	GND	Package bottom must also be connected to RF/DC ground.	
2	LO	This pin is DC coupled and matched to 50 Ohm from 24 to 32 GHz.	
5	IF	This pin is DC coupled. For applications not requiring operation to DC, this port should be DC blocked externally using a series capacitor whose value has been chosen to pass the necessary IF frequency range. For operation to DC, this pin must not source or sink more than 2 mA of current or part non-function and possible part failure will result.	
8	RF	This pin is DC coupled and matched to 50 Ohm from 24 to 32 GHz.	
10, 11, 12	N/C	No connection required. These pins may be connected to RF/DC ground without affecting performance.	

Evaluation PCB



List of Materials for Evaluation PCB 109952 [1]

Item	Description
J1 - J2	SRI SMA Connector
J3	Johnson SMA Connector
U1	HMC329LC3B Mixer
PCB [2]	108777 Evaluation PCB

[1] Reference this number when ordering complete evaluation PCB

[2] Circuit Board Material: Rogers 4350

The circuit board used in this application should use RF circuit design techniques. Signal lines should have 50 ohm impedance while the package ground leads and exposed paddle should be connected directly to the ground plane similar to that shown. A sufficient number of VIA holes should be used to connect the top and bottom ground planes. The evaluation board should be mounted to an appropriate heat sink. The evaluation circuit board shown is available from Hittite upon request.